

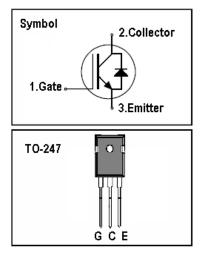
## IGBT

### Features

- 1200V,15A
- V<sub>CE(sat)(typ.)</sub>=2.2V@V<sub>GE</sub>=15V,I<sub>C</sub>=15A
- High speed switching
- Higher system efficiency
- Soft current turn-off waveforms
- Square RBSOA using NPT technology

### **General Description**

JIAEN NPT IGBTs offer lower losses and higher energy efficiency for application such as IH (induction heating),UPS, general inverter and other soft switching applications.



## Absolute Maximum Ratings

Symbol	Parameter	Value	Units	
Vces	Collector-Emitter Voltage	1200	V	
V <sub>GES</sub>	Gate-Emitter Voltage	<u>+</u> 20	V	
	Continuous Collector Current (Tc=25 °C)	30	A	
lc	Continuous Collector Current (Tc=100°C)	15	А	
Ісм	Pulsed Collector Current (Note 1)	45	A	
lF	Diode Continuous Forward Current ( Tc=100 ℃)	15	A	
lfм	Diode Maximum Forward Current (Note 1)	45	А	
t <sub>sc</sub>	Short Circuit Withstand Time	10	us	
D-	Maximum Power Dissipation (Tc=25 °C)	180	W	
PD	P <sub>D</sub> Maximum Power Dissipation (T <sub>c</sub> =100°C)		W	
TJ	Operating Junction Temperature Range	-55 to +150	°C	
Tstg	Storage Temperature Range	-55 to +150	°C	

### **Thermal Characteristics**

Symbol	Parameter	Max.	Units	
Rth j-c	Rth j-c Thermal Resistance, Junction to case for IGBT		°C/W	
Rth j-c	R <sub>th j-c</sub> Thermal Resistance, Junction to case for Diode		°C/W	
R <sub>th j-a</sub>	Rth j-a Thermal Resistance, Junction to Ambient		°C/W	



### Electrical Characteristics (Tc=25°C unless otherwise noted )

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
BV <sub>CES</sub>	Collector-Emitter Breakdown Voltage	V <sub>GE</sub> = 0V, I <sub>C</sub> = 250uA	1200	-	-	V
I <sub>CES</sub>	Collector-Emitter Leakage Current	V <sub>CE</sub> = 1200V, V <sub>GE</sub> = 0V	-	-	250	uA
	Gate Leakage Current, Forward	$V_{GE}$ =30V, $V_{CE}$ = 0V	-	-	100	nA
I <sub>GES</sub>	Gate Leakage Current, Reverse	$V_{GE}$ = -30V, $V_{CE}$ = 0V	-	-	-100	nA
$V_{GE(th)}$	Gate Threshold Voltage	$V_{GE} = V_{CE}, I_C = 250 \text{uA}$	4	-	6	V
V <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage	V <sub>GE</sub> =15V, I <sub>C</sub> = 15A	-	2.2	2.7	V
Qg	Total Gate Charge	Vcc=960V	-	70		nC
Qge	Gate-Emitter Charge	V <sub>GE</sub> =15V I <sub>C</sub> =15A	-	23		nC
Q <sub>gc</sub>	Gate-Collector Charge		-	24		nC
t d(on)	Turn-on Delay Time		-	30	-	ns
t r	Turn-on Rise Time	V <sub>cc</sub> =600V V <sub>GE</sub> =15V I <sub>c</sub> =15A R <sub>G</sub> =28Ω Inductive Load T <sub>c</sub> =25 ℃	-	35	-	ns
t d(off)	Turn-off Delay Time		-	260	-	ns
t f	Turn-off Fall Time		-	135	-	ns
Eon	Turn-on Switching Loss		-	1.3	-	mJ
Eoff	Turn-off Switching Loss		-	0.9	-	mJ
Ets	Total Switching Loss		-	2.2	-	mJ
Cies	Input Capacitance	V <sub>CE</sub> =25V	-	550	-	pF
Coes	Output Capacitance	V <sub>GE</sub> =0V	-	180	-	pF
Cres	Reverse Transfer Capacitance	f = 100kHz	-	110	-	pF

### Electrical Characteristics of Diode (Tc=25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
V <sub>F</sub>	Diode Forward Voltage	I <sub>F</sub> =15A	-	2.3	2.8	V
trr	Diode Reverse Recovery Time	V <sub>CE</sub> = 600V	-	240		ns
lrr	Diode peak Reverse Recovery Current	I <sub>F</sub> = 15A	-	13		А
Qr r	Diode Reverse Recovery Charge	dIF/dt = 400A/us	-	2000		nC

### Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature



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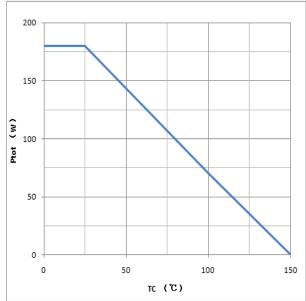
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## **JNG15N120HS2**

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**Typical Performance Characteristics** 



## Figure1:maximum DC collector current VS. case temprature

TC (°ී)

100

50

Figure2:power dissipation VS. case temprature

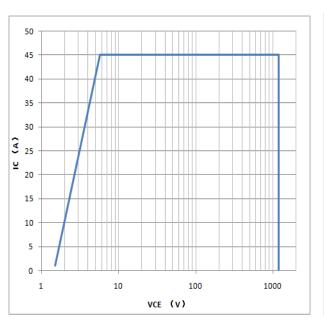
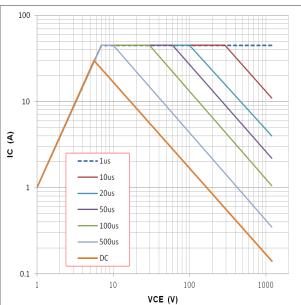
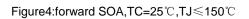


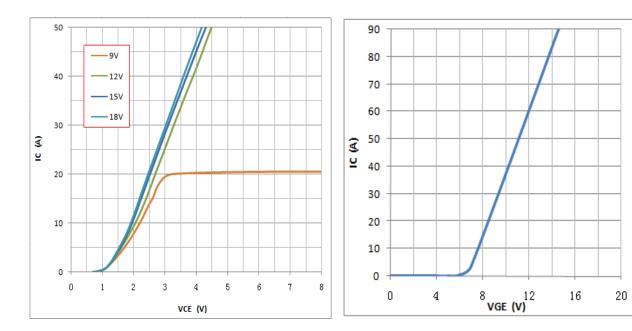
Figure3:reverse bias SOA,TJ=150°C,VGE=15V





150





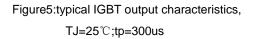
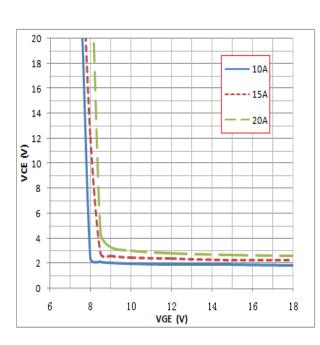


Figure6:typical trans characteristics,VCE=20V,tp=20us



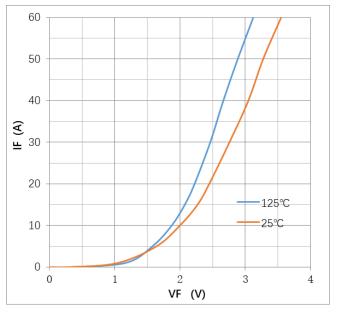


Figure7: typical VCE VS. VGE,TJ=25°C

Figure8:typical diode forward characteristic,tp=300us



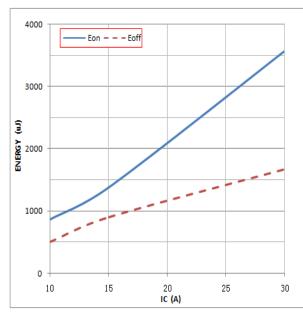


Figure9: typical energy loss VS. IC, TC=25  $^\circ\!C$ , L=500uH, VCE=600V,VGE=15V,Rg=28  $^\Omega$ 

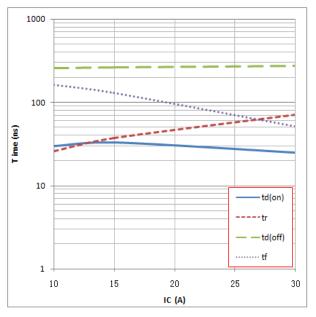


Figure10: typical switching time VS. IC, TC=25 $^\circ\!\mathrm{C}$ , L=500uH, VCE=600V,VGE=15V,Rg=28 $\Omega$ 

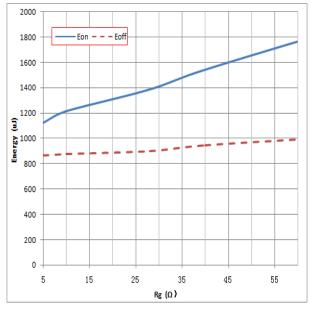
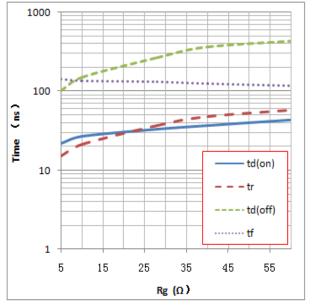
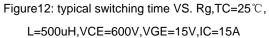
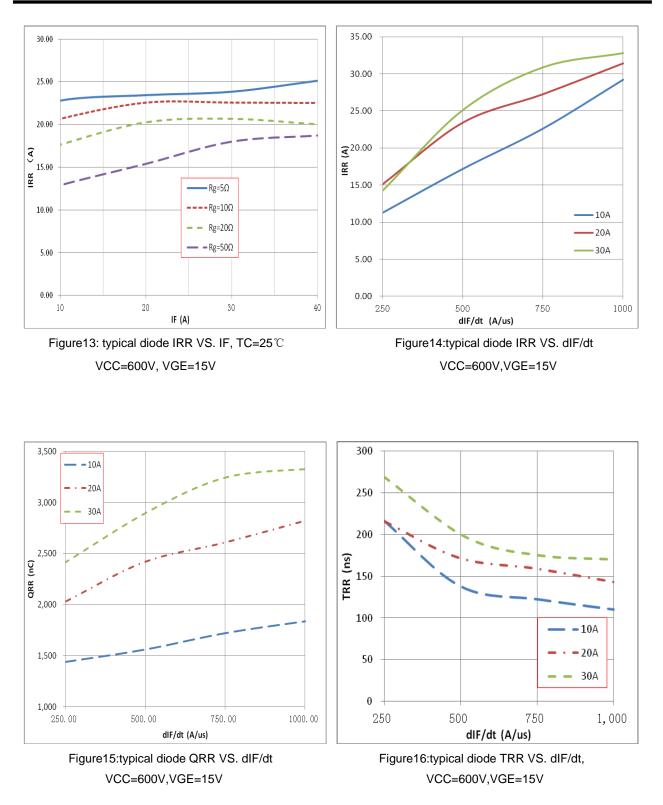


Figure11: typical energy loss VS. Rg,TC=25 $^{\circ}$ C, L=500uH, VCE=600V, VGE=15V,IC=15A











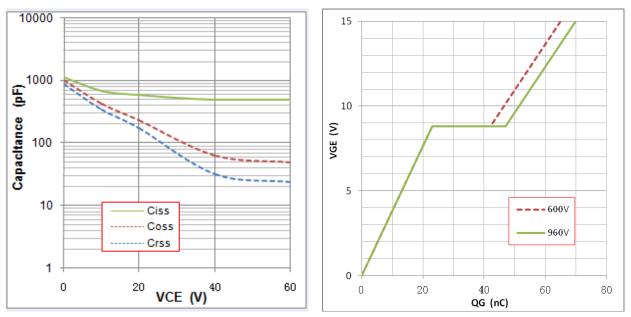
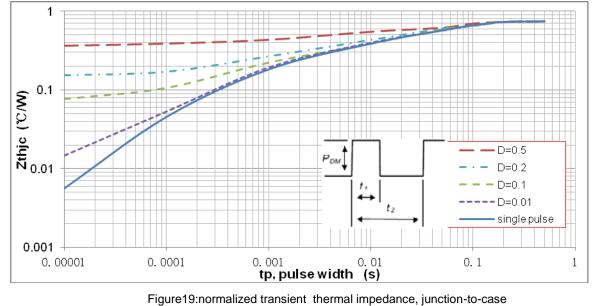


Figure17:typical capacitance VS. VCE,VGE=0V,f=100kHz Fig

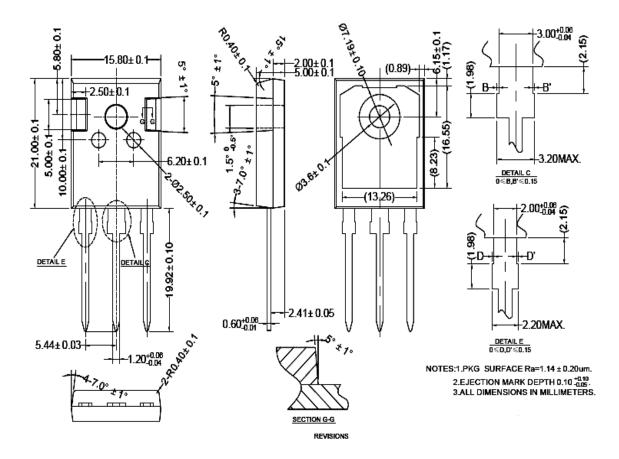
Figure18:typical gate charge VS. VGE,IC=15A



Note1.Duty factor D=t1/t2; Note2:peak TJ=PDM×Zthjc+TC



### **TO247 PACKAGE OUTLINE**



会差标注	公差值	表面粗糙度
0	±0.2	Ra3.2~6.3
0.0	±0.1	Ra1.6~3.2
0.00	±0.01	Ra0.8~1.6
0.000	±0.005	Ra0.4~0.8
0.0000	±0.002	Ra0.2~0.4

#### 0≤D,D'≤0.15

NOTES:1.PKG\_SURFACE Ra=1.14 ± 0.20um. 2.EJECTION MARK DEPTH 0.10 +0.10 -0.05 3.ALL DIMENSIONS IN MILLIMETERS.



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